

Abstract

A heat dissipation device for dissipating heat produced by electronic components of an electronic control device is disclosed. The electronic control device includes a circuit board and a protective case. The electronic components are mounted on the circuit board. The case substantially confines the circuit board. The heat dissipation device includes heat conductive terminals. The heat conductive terminals are connected to the circuit board in positions proximate to the respective electronic components, so that the heat of the electronic components is transferred or conducted to the heat conductive terminals. The heat conductive terminals are connected to the case body in order to further conduct the heat to the case body.